

September 1983 Revised February 1999

MM74HC175 Quad D-Type Flip-Flop With Clear

General Description

The MM74HC175 high speed D-type flip-flop with complementary outputs utilizes advanced silicon-gate CMOS technology to achieve the high noise immunity and low power consumption of standard CMOS integrated circuits, along with the ability to drive 10 LS-TTL loads.

Information at the \underline{D} inputs of the MM74HC175 is transferred to the Q and \overline{Q} outputs on the positive going edge of the clock pulse. Both true and complement outputs from each flip flop are externally available. All four flip-flops are controlled by a common clock and a common CLEAR. Clearing is accomplished by a negative pulse at the CLEAR input. All four Q outputs are cleared to a logical "0" and all four \overline{Q} outputs to a logical "1."

The 74HC logic family is functionally as well as pin-out compatible with the standard 74LS logic family. All inputs are protected from damage due to static discharge by internal diode clamps to V_{CC} and ground.

Features

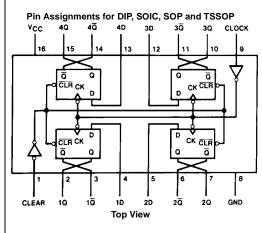
- Typical propagation delay: 15 ns
- Wide operating supply voltage range: 2-6V
- Low input current: 1 µA maximum
- Low quiescent supply current: 80 µA maximum (74HC)
- High output drive current: 4 mA minimum (74HC)

Ordering Code:

Order Number	Package Number	Package Description
MM74HC175M	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
MM74HC175SJ	M16D	16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
MM74HC175MTC	MTC16	16-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
MM74HC175N	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0,300" Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code

Connection Diagram



Truth Table

(Each Flip-Flop)

l I	Outputs			
Clear	D	Q	Q	
L	Х	Х	L	Н
Н	1	Н	Н	L
Н	1	L	L	Н
Н	L	Χ	Q_0	Q_0

- H = HIGH Level (steady state)
- L = LOW Level (steady state)
- X = Irrelevant
- ↑ = Transition from LOW-to-HIGH level
- $\mathbf{Q}_0\!=\!\mathsf{The}$ level of Q before the indicated steady-state input conditions were established

MM74HC175 Logic Diagram

Absolute Maximum Ratings(Note 1)

(Note 2)

Supply Voltage (V _{CC})	-0.5 to +7.0V
DC Input Voltage (V _{IN})	-1.5 to V_{CC} +1.5V
DC Output Voltage (V _{OUT})	-0.5 to V_{CC} +0.5 V
Clamp Diode Current (I _{IK} , I _{OK})	±20 mA
DC Output Current, per pin (I _{OUT})	±25 mA
DC V_{CC} or GND Current, per pin (I_{CC})	±50 mA
Storage Temperature Range (T _{STG})	-65°C to +150°C
Power Dissipation (P _D)	
(Note 3)	600 mW
S.O. Package only	500 mW
Lead Temperature (T _L)	
(Soldering 10 seconds)	260°C

Recommended Operating Conditions

	Min	Max	Units
Supply Voltage (V _{CC})	2	6	V
DC Input or Output Voltage			
(V_{IN}, V_{OUT})	0	V_{CC}	V
Operating Temperature Range (T _A)	-40	+85	°C
Input Rise or Fall Times			
(t_r, t_f) $V_{CC} = 2.0V$		1000	ns
$V_{CC} = 4.5V$		500	ns
$V_{CC} = 6.0V$		400	ns

Note 1: Absolute Maximum Ratings are those values beyond which damage to the device may occur.

Note 2: Unless otherwise specified all voltages are referenced to ground.

Note 3: Power Dissipation temperature derating — plastic "N" package: –
12 mW/°C from 65°C to 85°C.

DC Electrical Characteristics (Note 4)

Symbol	Parameter	Conditions	V _{CC}	T _A = 25°C		$T_A = -40 \text{ to } 85^{\circ}\text{C}$	T _A = -55 to 125°C	Units
Syllibol		Conditions	*CC	Тур		Guaranteed L		
V _{IH}	Minimum HIGH Level		2.0V		1.5	1.5	1.5	V
	Input Voltage		4.5V		3.15	3.15	3.15	V
			6.0V		4.2	4.2	4.2	V
V _{IL}	Maximum LOW Level		2.0V		0.5	0.5	0.5	V
	Input Voltage		4.5V		1.35	1.35	1.35	V
			6.0V		1.8	1.8	1.8	V
V _{OH}	Minimum HIGH Level	$V_{IN} = V_{IH}$ or V_{IL}						
	Output Voltage	$ I_{OUT} \le 20 \ \mu A$	2.0V	2.0	1.9	1.9	1.9	V
			4.5V	4.5	4.4	4.4	4.4	V
			6.0V	6.0	5.9	5.9	5.9	V
		$V_{IN} = V_{IH}$ or V_{IL}						
		$ I_{OUT} \le 4.0 \text{ mA}$	4.5V	4.2	3.98	3.84	3.7	V
		$ I_{OUT} \le 5.2 \text{ mA}$	6.0V	5.7	5.48	5.34	5.2	V
V _{OL}	Maximum LOW Level	$V_{IN} = V_{IH}$ or V_{IL}						
	Output Voltage	$ I_{OUT} \le 20 \mu A$	2.0V	0	0.1	0.1	0.1	V
			4.5V	0	0.1	0.1	0.1	V
			6.0V	0	0.1	0.1	0.1	V
		$V_{IN} = V_{IH}$ or V_{IL}						
		$ I_{OUT} \le 4.0 \text{ mA}$	4.5V	0.2	0.26	0.33	0.4	V
		$ I_{OUT} \le 5.2 \text{ mA}$	6.0V	0.2	0.26	0.33	0.4	V
I _{IN}	Maximum Input	$V_{IN} = V_{CC}$ or GND	6.0V		±0.1	±1.0	±1.0	μА
	Current							
I _{CC}	Maximum Quiescent	V _{IN} = V _{CC} or GND	6.0V		8	80	160	μА
	Supply Current	$I_{OUT} = 0 \mu A$						

Note 4: For a power supply of 5V $\pm 10^{\rm N}$ the worst case output voltages (V_{OH}, and V_{OL}) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at V_{CC} = 5.5V and 4.5V respectively. (The V_{IH} value at 5.5V is 3.85V.) The worst case leakage current (I_{IN}, I_{CC}, and I_{OZ}) occur for CMOS at the higher voltage and so the 6.0V values should be used.

AC Electrical Characteristics

 $V_{CC} = 5V$, $T_A = 25^{\circ}C$, $C_L = 15$ pF, $t_r = t_f = 6$ ns

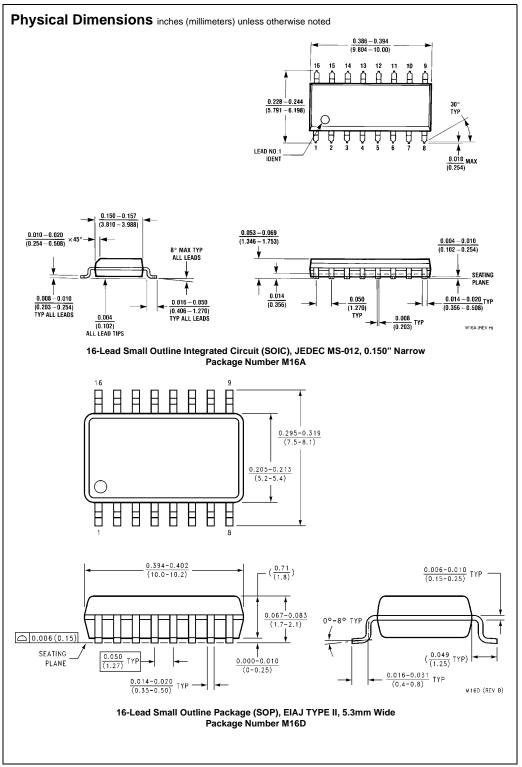
Symbol	Parameter	Conditions	Тур	Guaranteed Limit	Units	
f _{MAX}	Maximum Operating		60	35	MHz	
	Frequency					
t _{PHL} , t _{PLH}	Maximum Propagation		15	25	ns	
	Delay, Clock to Q or Q					
t _{PHL} , t _{PLH}	Maximum Propagation		13	21	ns	
	Delay, Reset to Q or Q					
t _{REC}	Minimum Removal			20	ns	
	Time, Clear to Clock					
t _S	Minimum Setup Time, Data to Clock			20	ns	
t _H	Minimum Hold Time, Data from Clock			0	ns	
t _W	Minimum Pulse Width, Clock or Clear		10	16	ns	

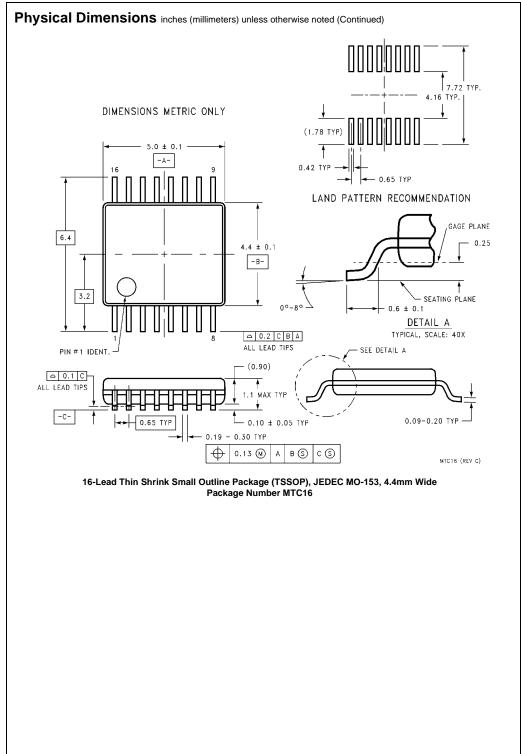
AC Electrical Characteristics

 $\rm V_{CC} = 2.0V$ to 6.0V, $\rm C_L = 50$ pF, $\rm t_f = t_f = 6$ ns (unless otherwise specified)

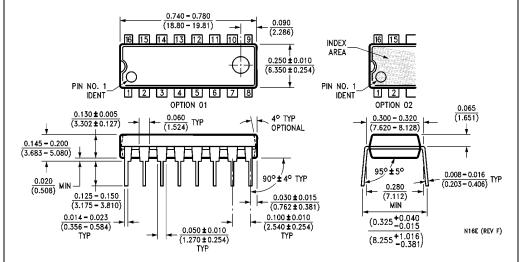
Symbol	Parameter	Conditions	v _{cc}	T _A = 25°C		T _A = -40 to 85°C	T _A = -55 to 125°C	Units
Oymboi				Тур		Guaranteed L	imits	Oille
f _{MAX}	Maximum Operating		2.0V	12	6	5	4	MHz
	Frequency		4.5V	60	30	24	20	MHz
			6.0V	70	35	28	24	MHz
t_{PHL}, t_{PLH}	Maximum Propagation		2.0V	80	150	190	225	ns
	Delay, Clock to Q or Q		4.5V	15	30	38	45	ns
			6.0V	13	26	32	38	ns
t _{PHL} , t _{PLH}	Maximum Propagation		2.0V	64	125	158	186	ns
	Delay, Reset to Q or Q		4.5V	14	25	32	37	ns
			6.0V	12	21	27	32	ns
t _{REM}	Minimum Removal Time		2.0V		100	125	150	ns
	Clear to Clock		4.5V		20	25	30	ns
			6.0V		17	21	25	ns
t _S	Minimum Setup Time		2.0V		100	125	150	ns
	Data to Clock		4.5V		20	25	30	ns
			6.0V		17	21	25	ns
t _H	Minimum Hold Time		2.0V		0	0	0	ns
	Data from Clock		4.5V		0	0	0	ns
			6.0V		0	0	0	ns
t _W	Minimum Pulse Width		2.0V	30	80	100	120	ns
	Clear or Clock		4.5V	9	16	20	24	ns
			6.0V	8	14	17	20	ns
t _r , t _f	Maximum Input Rise and		2.0V		1000	1000	1000	ns
	Fall Time		4.5V		500	500	500	ns
			6.0V		400	400	400	ns
t _{TLH} , t _{THL}	Maximum		2.0V	30	75	95	110	ns
	Output Rise and		4.5V	9	15	19	22	ns
	Fall Time		6.0V	8	13	16	19	ns
C _{PD}	Power Dissipation	(per package)		150				pF
	Capacitance (Note 5)	(per package)						
C _{IN}	Maximum Input			5	10	10	10	pF
	Capacitance							

Note 5: C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD}$ $V_{CC}^2 f + I_{CC}$ V_{CC} , and the no load dynamic current consumption, $I_S = C_{PD}$ V_{CC} $f + I_{CC}$.





Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N16E

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